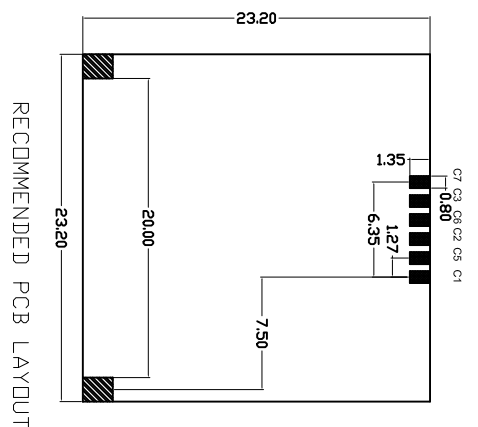
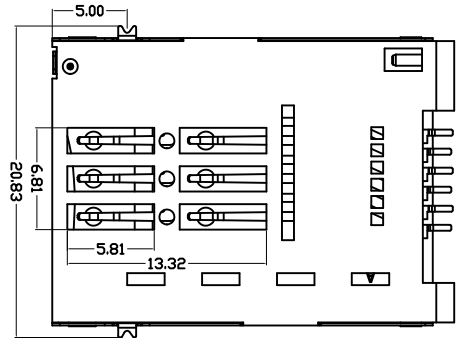
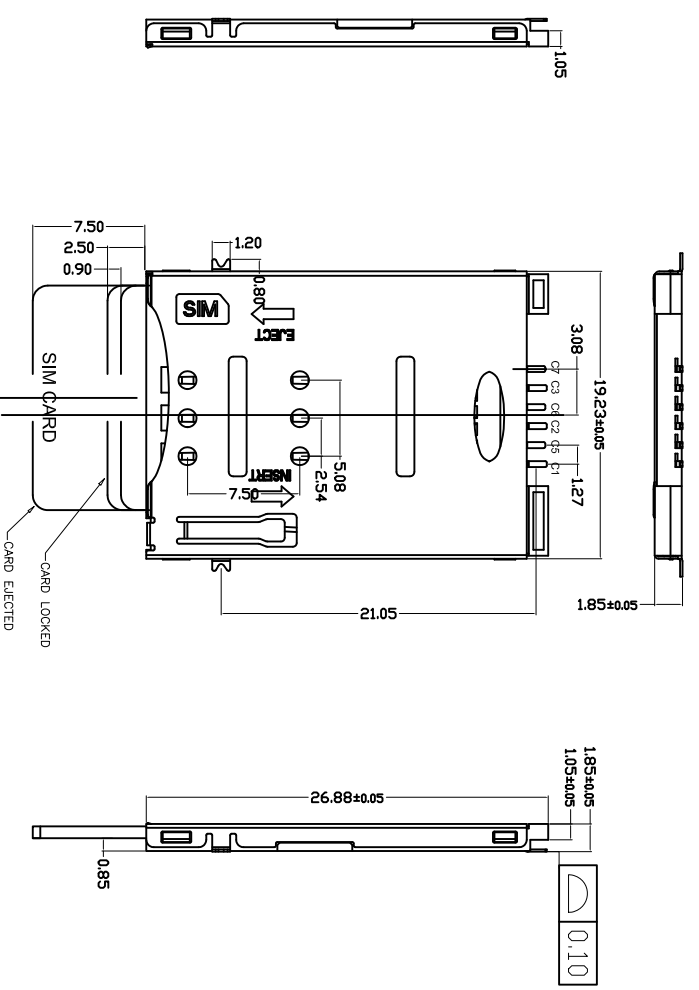


REV	DESCRIPTION	ECN NO	DATE



RECOMMENDED PCB LAYOUT

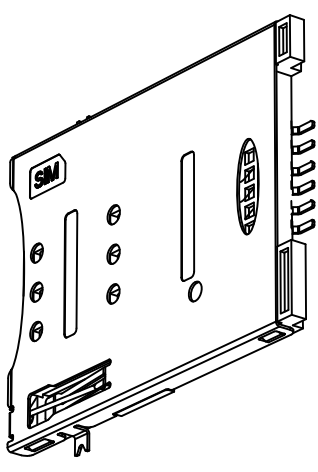


1. SPECIFICATIONS
 INSULATION RESISTANCE: 500M min. AT DC 500V DC
 WITHSTANDING VOLTAGE: 250V AC rms FOR 1 MINUTE
 CONTACT RESISTANCE: 100M max. AT 10MA/20mV max
 CURRENT RATING: 0.5A
 VOLTAGE RATING: 5.0 Vrms
 OPERATING TEMP RANGE: -55 C+85 C
 MATING CYCLES: 5000 INSERTIONS

2. MATERIAL:
 INSULATOR: H-TEMPERATURE PLASTIC/UL 94V-0,
 COLOR: BLACK
 TERMINAL: COPPER ALLOY T=0.15mm
 SHELL: STAINLESS STEEL, I=0.15mm

3. FINISH:
 TERMINAL: 50μ" min NICKEL UNDERPLATED ON ALLOYER, GOLD PLATING
 ON CONTACT AREA, 80μ" min TIN ON SOLDER TAIL
 SHELL: 50μ" NICKEL UNDERPLATED ON ALLOYER, GOLD FLASH ON SOLDER
 LATCH

PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O



GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		TITLE:		
XX	±0.25	DRAWN BY:	DATE	SIM Card Push 6Pin 贴片式		
XXX	±0.15	Checked BY:	DATE	PART NO: SIM-003		
XXXX	±0.05	APPERIAL BY:	DATE	SIZE: A4		
				THIRD ANGLE PROJECTION		SCALE: ---
						SHEET NO: 1 OF 1

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